

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of	:	Customer Number: 89518
	:	
Jin-Yuan Lee, et al.	:	Confirmation Number: 7456
	:	
Application No.: 10/055,499	:	Group Art Unit: 2891
	:	
Patent No.: 7,413,929	:	Issued: August 19, 2008
	:	

For: INTEGRATED CHIP PACKAGE STRUCTURE USING ORGANIC SUBSTRATE AND
METHOD OF MANUFACTURING THE SAME

TRANSMITTAL OF POWER OF ATTORNEY

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

CERTIFICATE OF ELECTRONIC TRANSMISSION

I hereby certify that this correspondence is being electronically-transmitted to the
United States Patent and Trademark Office on March 23, 2011,
/Patricia A. Balero/
Patricia A. Balero

Sir:

Transmitted herewith is a Fee Address Indication Form, Power Of Attorney to Prosecute
Applications Before the USPTO, together with a Statement Under 37 CFR 3.73(b), which
revokes all previous powers of attorney given in the above-identified application and associates
the application with Customer Number 89518.

Respectfully submitted,

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